



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Prod Compliance Engineer		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-10-09	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1888810-2	<b>Amount</b>	9002.971	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	EMI/Dust Cover,XFP And QSFP	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0117</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	EMI/Dust Cover,XFP and SFP				1.0	9002.971	mg	
Material	2	Copper Plate				1.0	84.34	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.08434	mg	
Substance	3	Copper	Supplier	7440-50-8	99.9	1.0	84.25566	mg	
Material	2	Nickel Plate				1.0	18.631	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	2.0E-4	1.0	3.7262E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	5.0E-4	1.0	9.3155E-5	mg	
Substance	3	Nickel	Nickel	7440-02-0	83.9989	1.0	15.64984	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	16.0	1.0	2.98096	mg	
Substance	3	Chromium	Supplier	7440-47-3	2.0E-4	1.0	3.7262E-5	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	2.0E-4	1.0	3.7262E-5	mg	
Material	2	Zinc Alloy				1.0	8900.0	mg	
Substance	3	Silicon	Supplier	7440-21-3	0.035	1.0	3.115	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.02	1.0	1.78	mg	
Substance	3	Tin	Supplier	7440-31-5	0.0030	1.0	0.267	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.06	1.0	5.34	mg	
Substance	3	Copper	Supplier	7440-50-8	0.25	1.0	22.25	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	1.0	0.89	mg	
Substance	3	Zinc	Supplier	7440-66-6	95.0315	1.0	8457.8035	mg	
Substance	3	Aluminum	Supplier	7429-90-5	4.3	1.0	382.7	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.89	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	0.089	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	1.0	8.9	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	8.9	mg	
Substance	3	Magnesium	Supplier	7439-95-4	0.05	1.0	4.45	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.02	1.0	1.78	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0050	1.0	0.445	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	0.0445	mg	

Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0040	1.0	0.356	mg	
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